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(12) **United States Design Patent**
Zhang et al.

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(54) **EARPHONE**

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(**) Term: **15 Years**

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(51) **LOC (13) Cl.** **14-01**

(52) **U.S. Cl.**
USPC **D14/223**

(58) **Field of Classification Search**
USPC D14/223, 205, 206; D24/174; 128/864,
128/865, 866; 381/380, 381; 455/90.3,
455/575.1, 569.1
CPC H04R 1/10; H04R 25/00; H04R 25/02;
H04R 1/1016; H04R 5/033; H04R
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See application file for complete search history.

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Primary Examiner — Paula Allen Greene

(57) **CLAIM**

The ornamental design for earphone, as shown and described.

DESCRIPTION

FIG. 1 is a perspective view of an earphone showing our new design, the opposite earphone shown in FIG. 9 is a mirror image thereof;

FIG. 2 is a perspective view thereof;

FIG. 3 is a front elevational view thereof;

FIG. 4 is a back elevational view thereof;

FIG. 5 is a left side view thereof;

FIG. 6 is a right side view thereof;

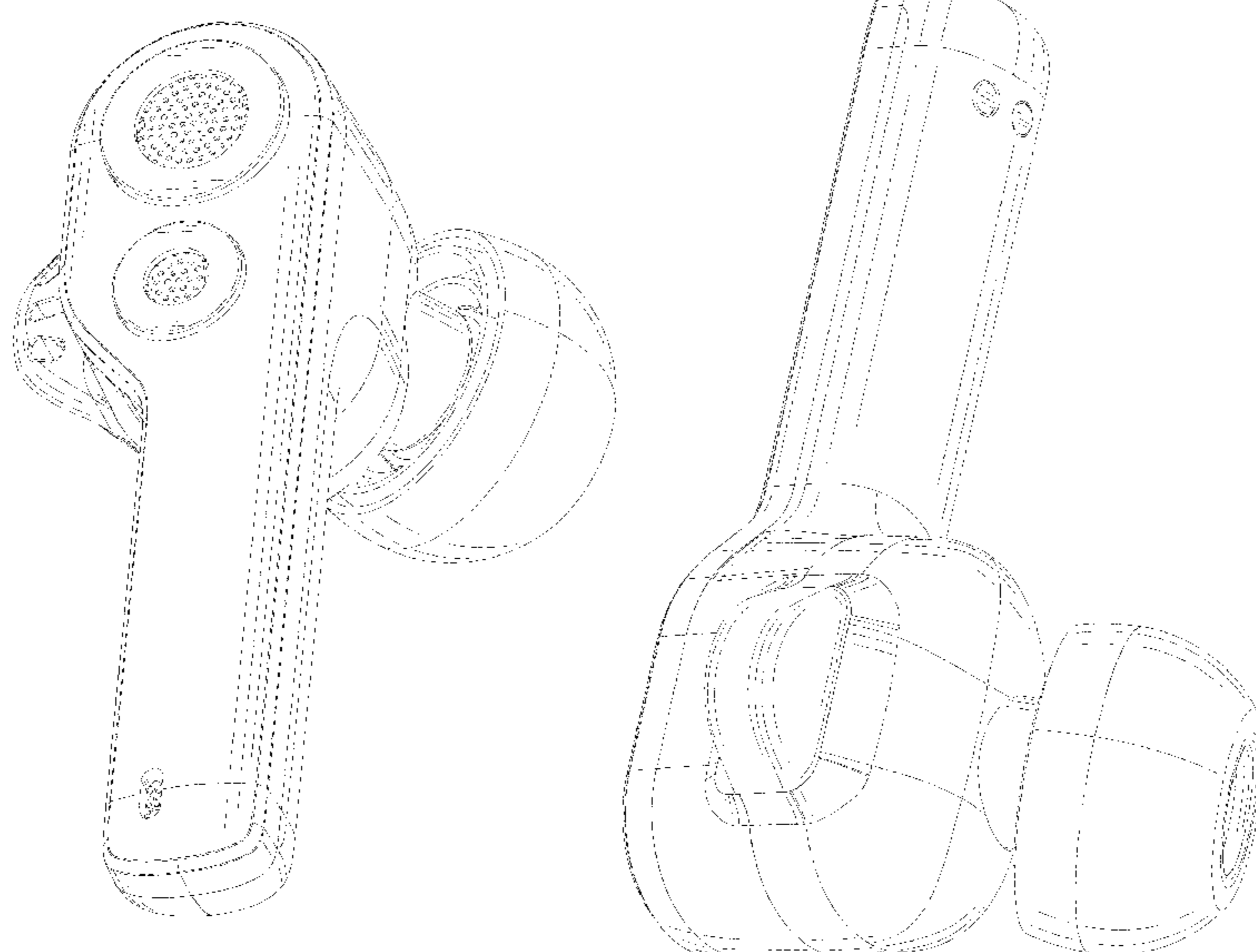
FIG. 7 is a top plan view thereof;

FIG. 8 is a bottom plan view thereof; and,

FIG. 9 is a perspective view of both earphones placed in the headset box thereof, the earphones are mirror images of each other.

The broken lines in the drawing depict environmental subject matter only and form no part of the claimed design.

1 Claim, 9 Drawing Sheets



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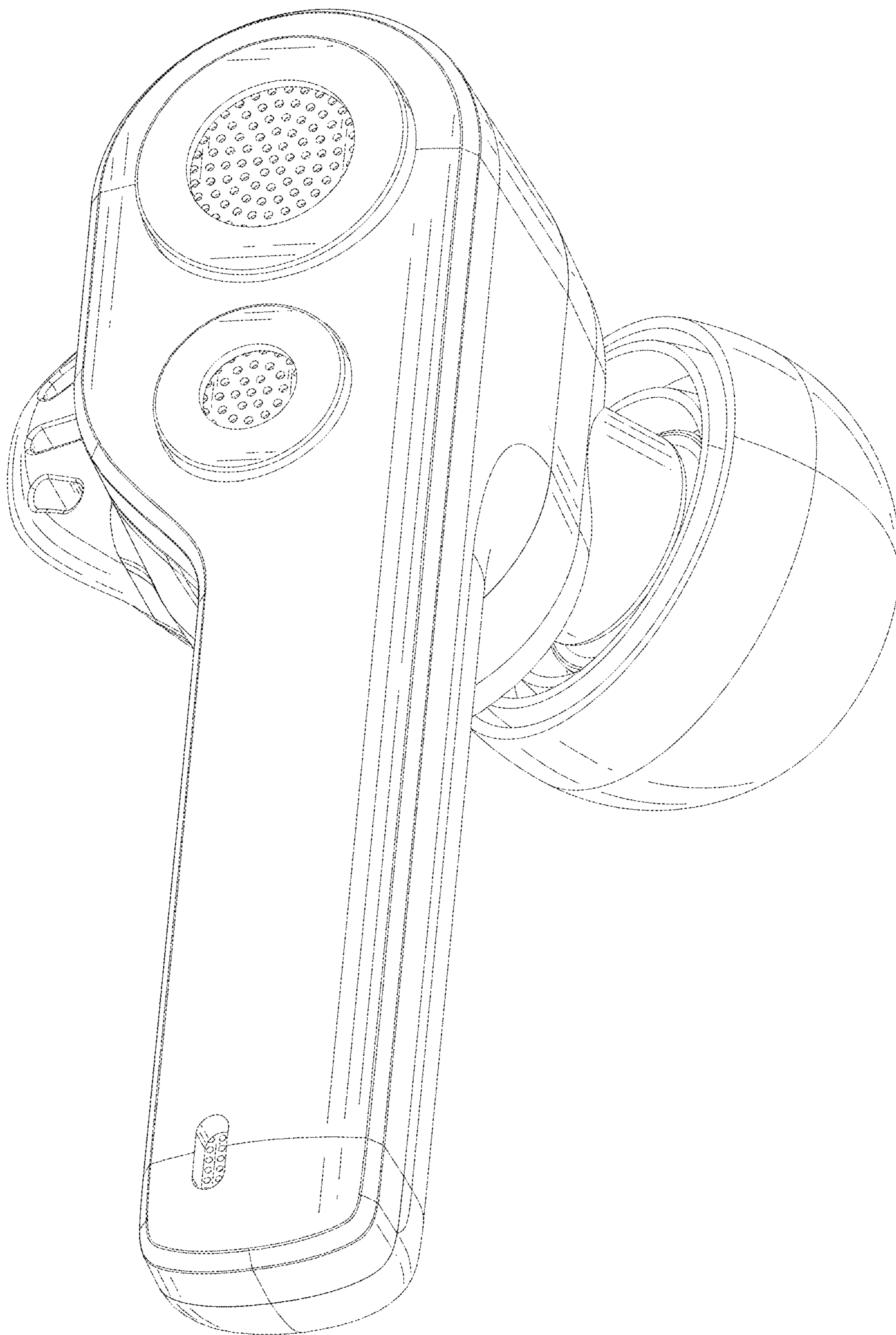


FIG. 1

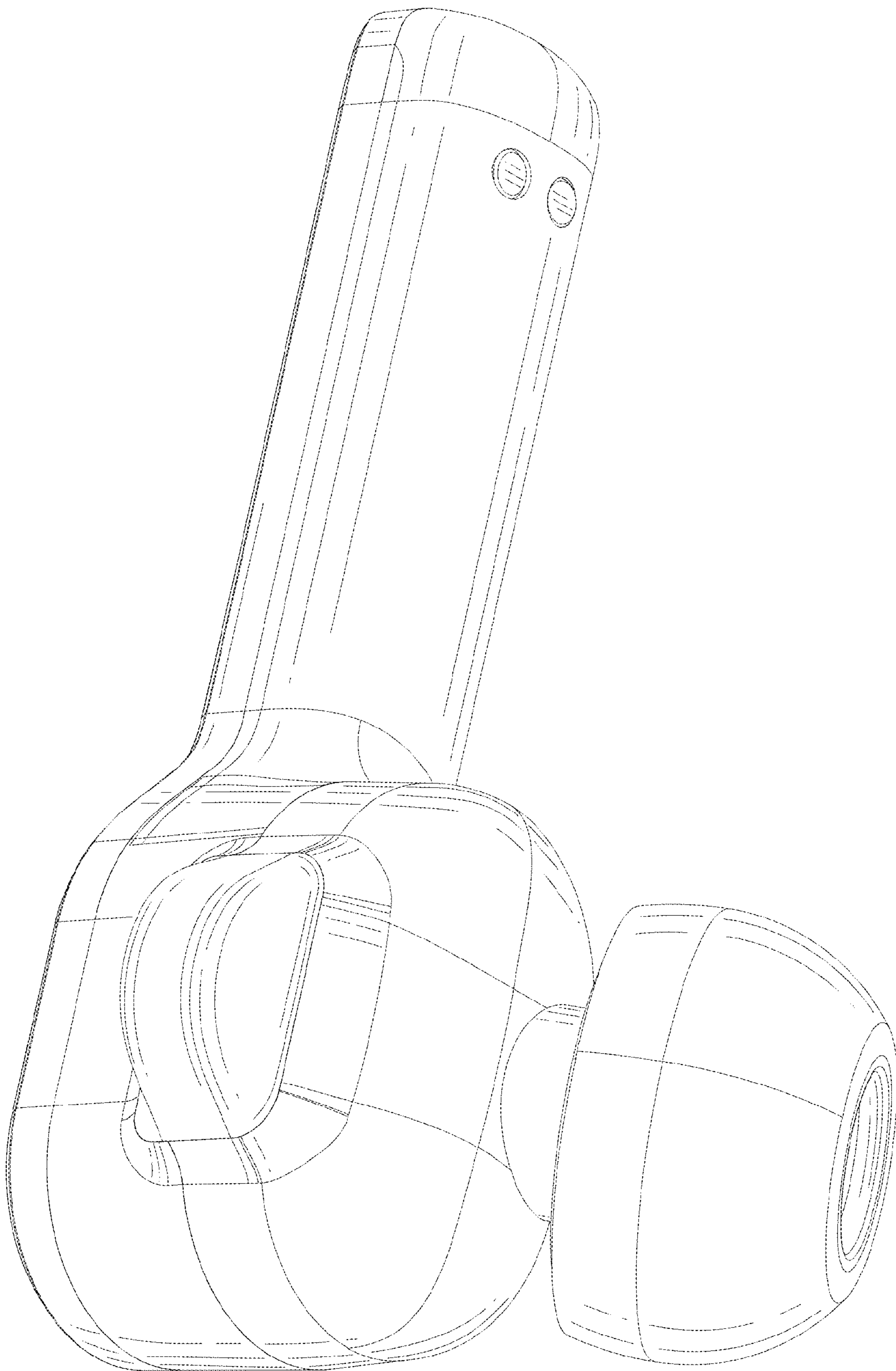


FIG. 2

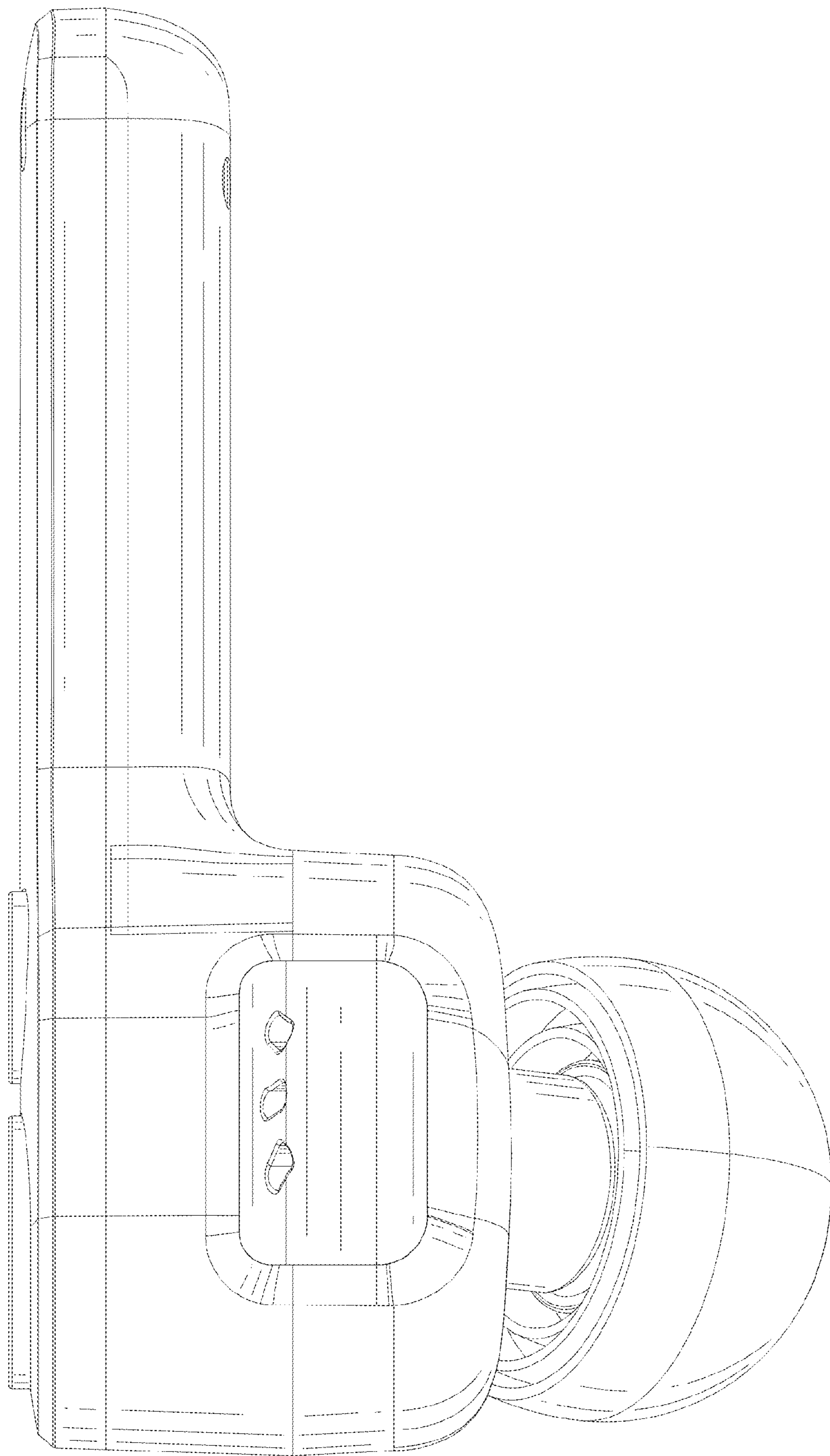


FIG. 3

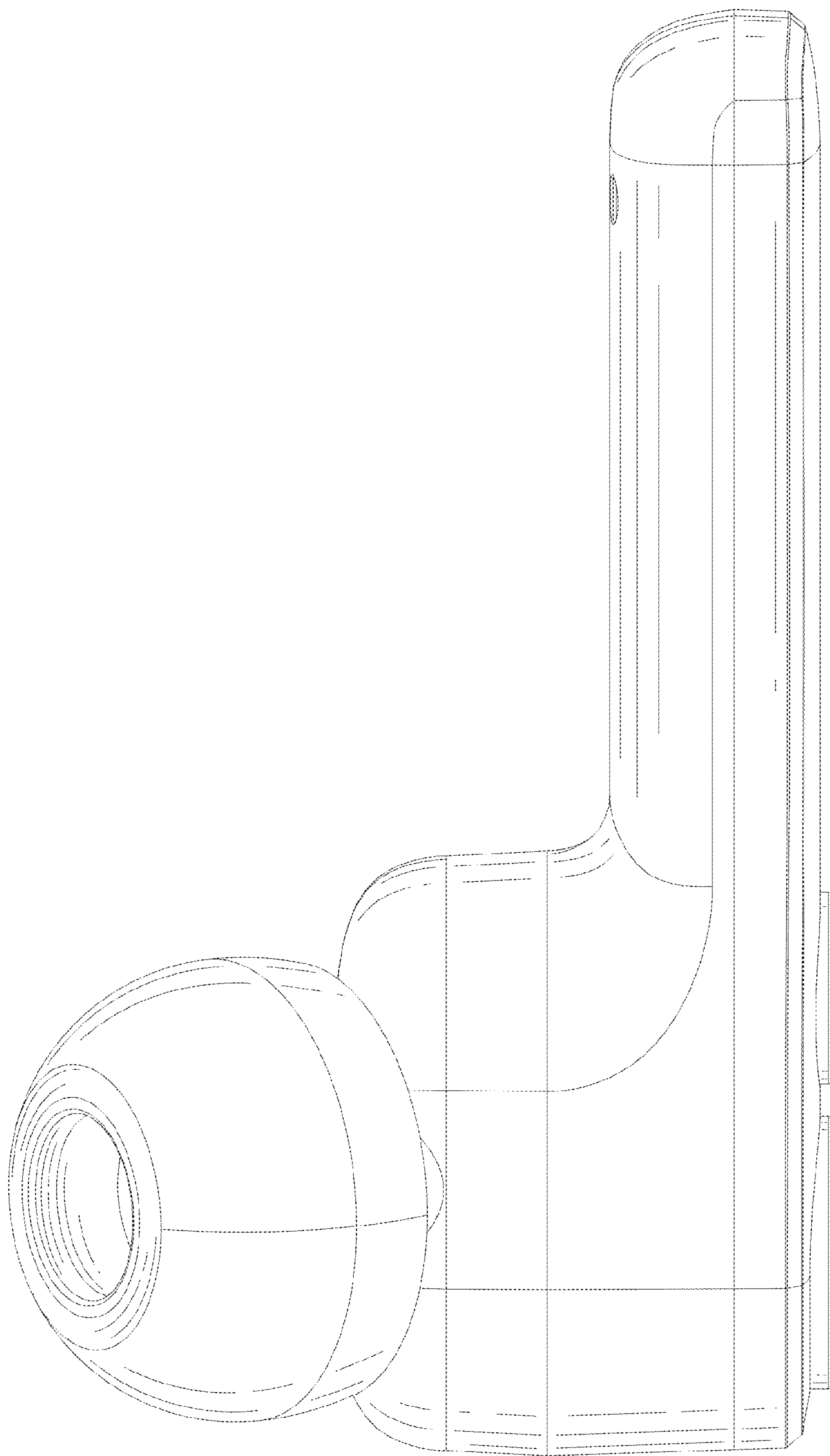


FIG. 4

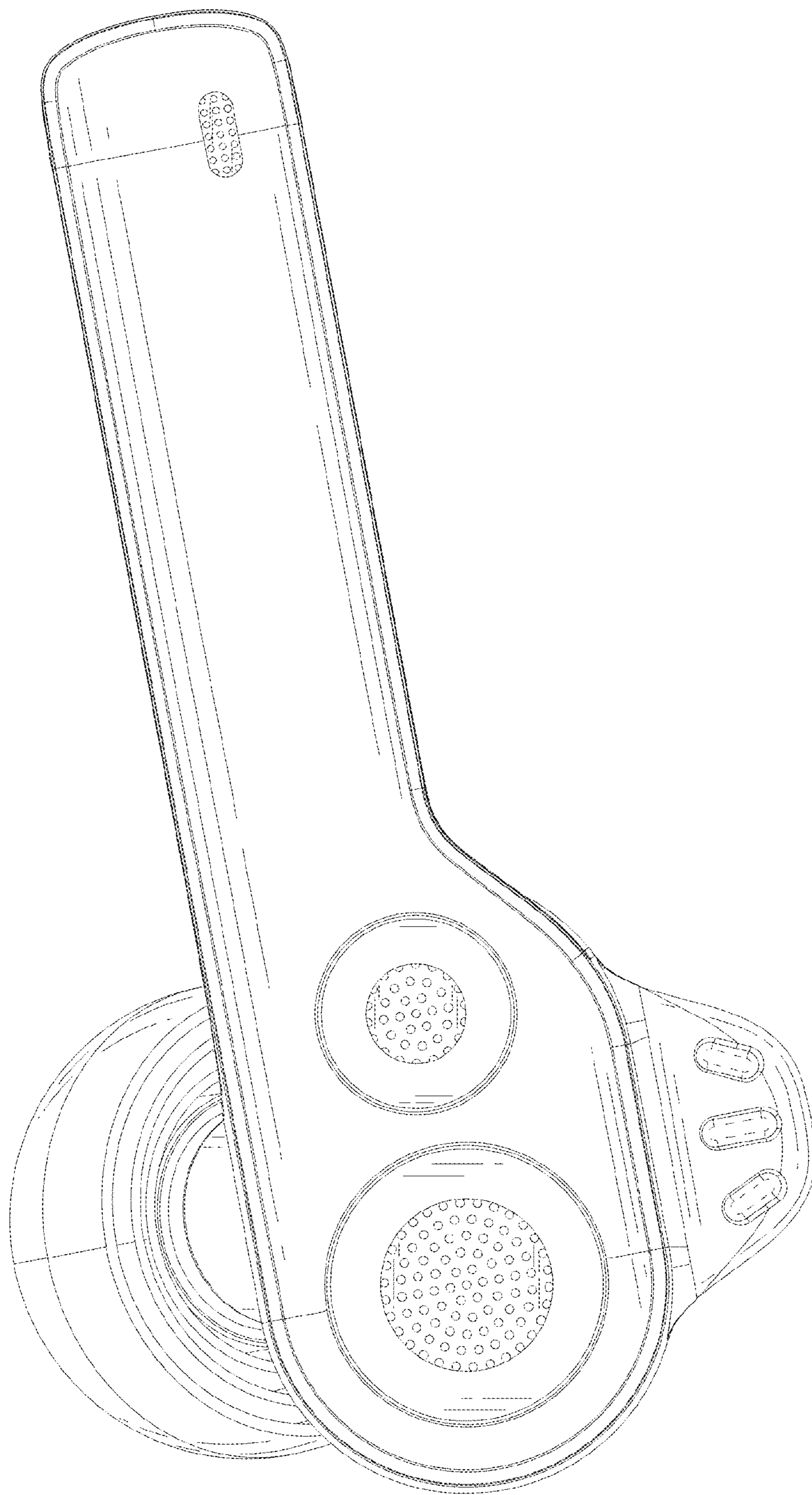


FIG. 5

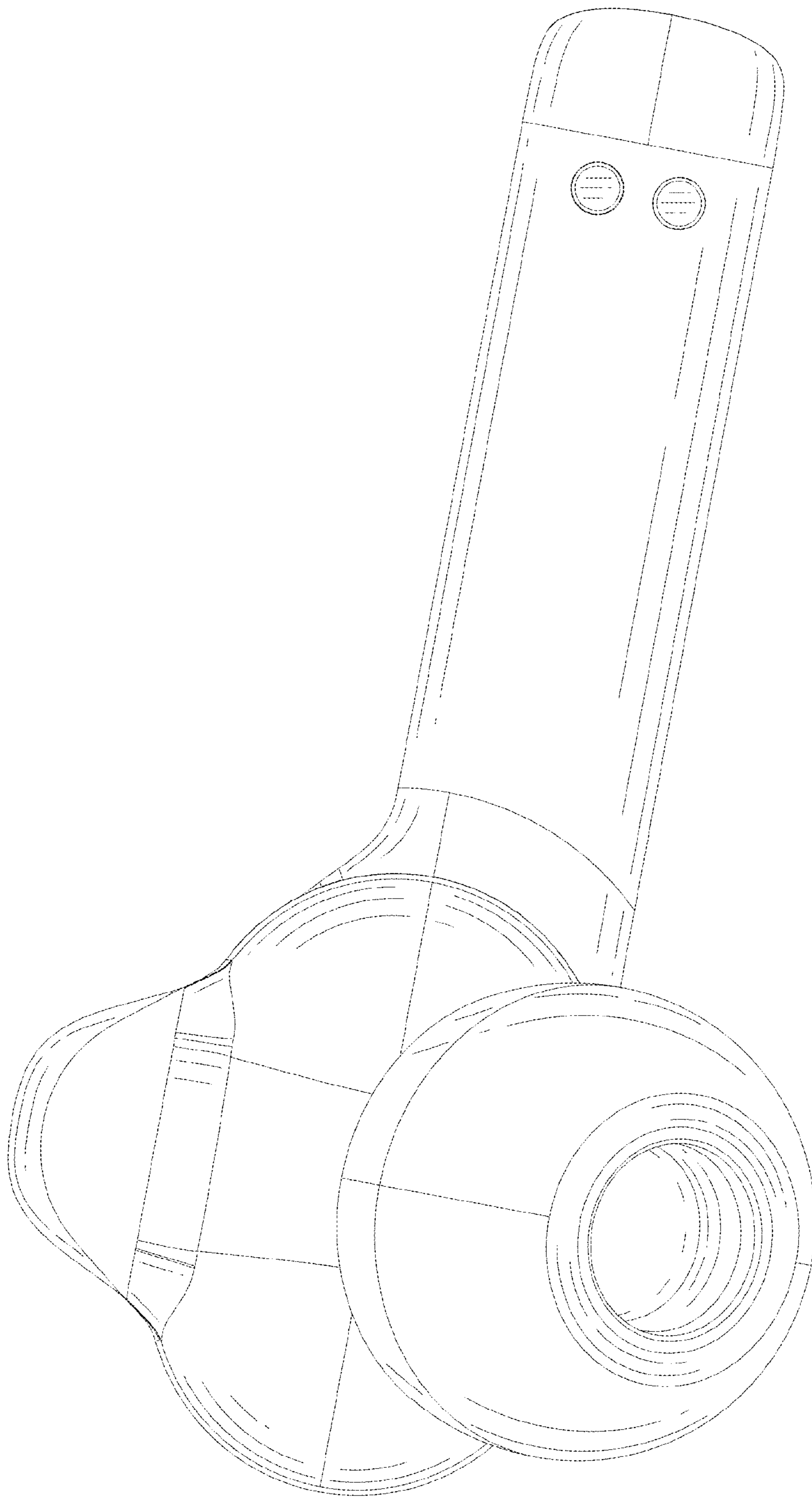


FIG. 6

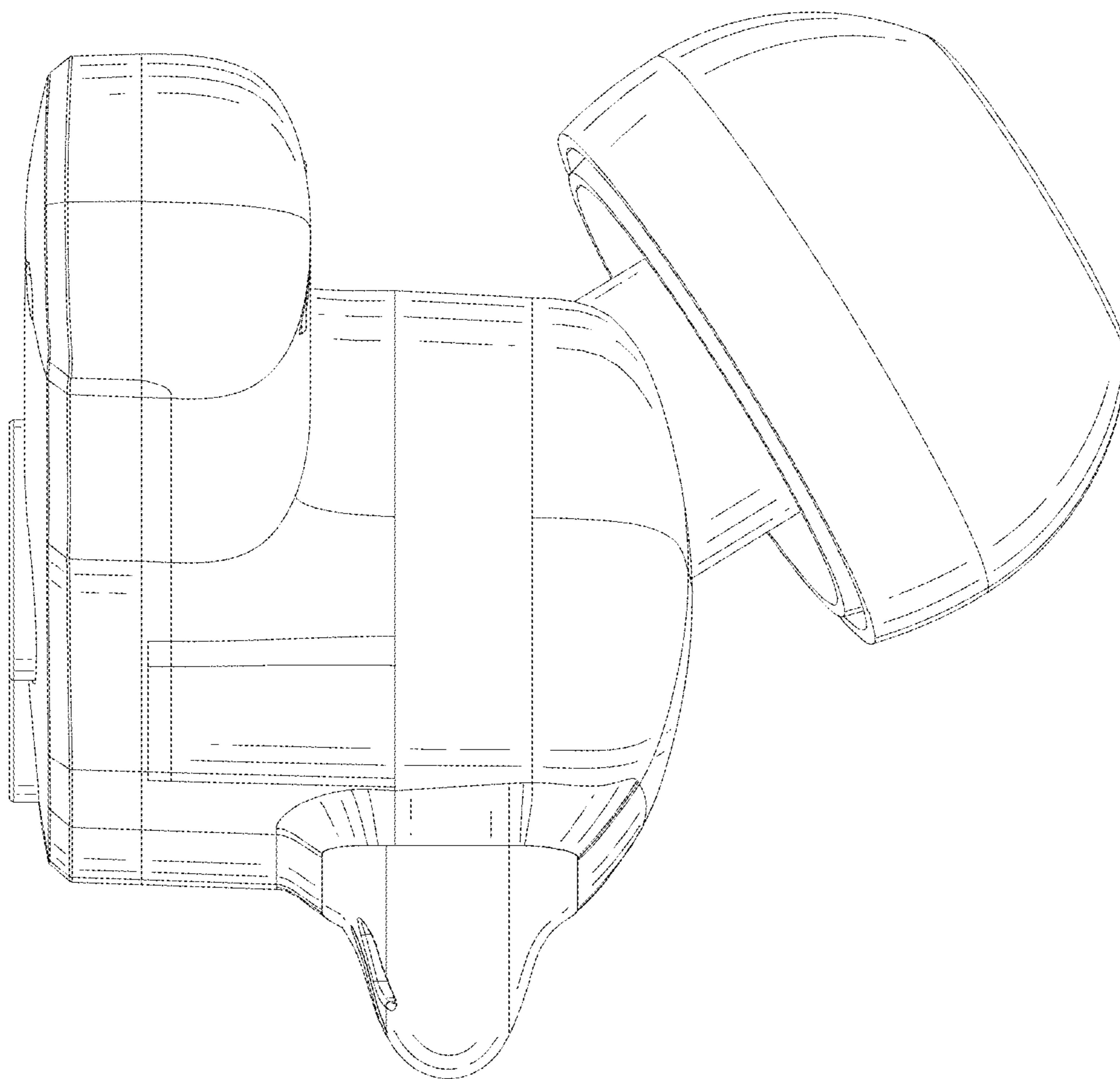


FIG. 7

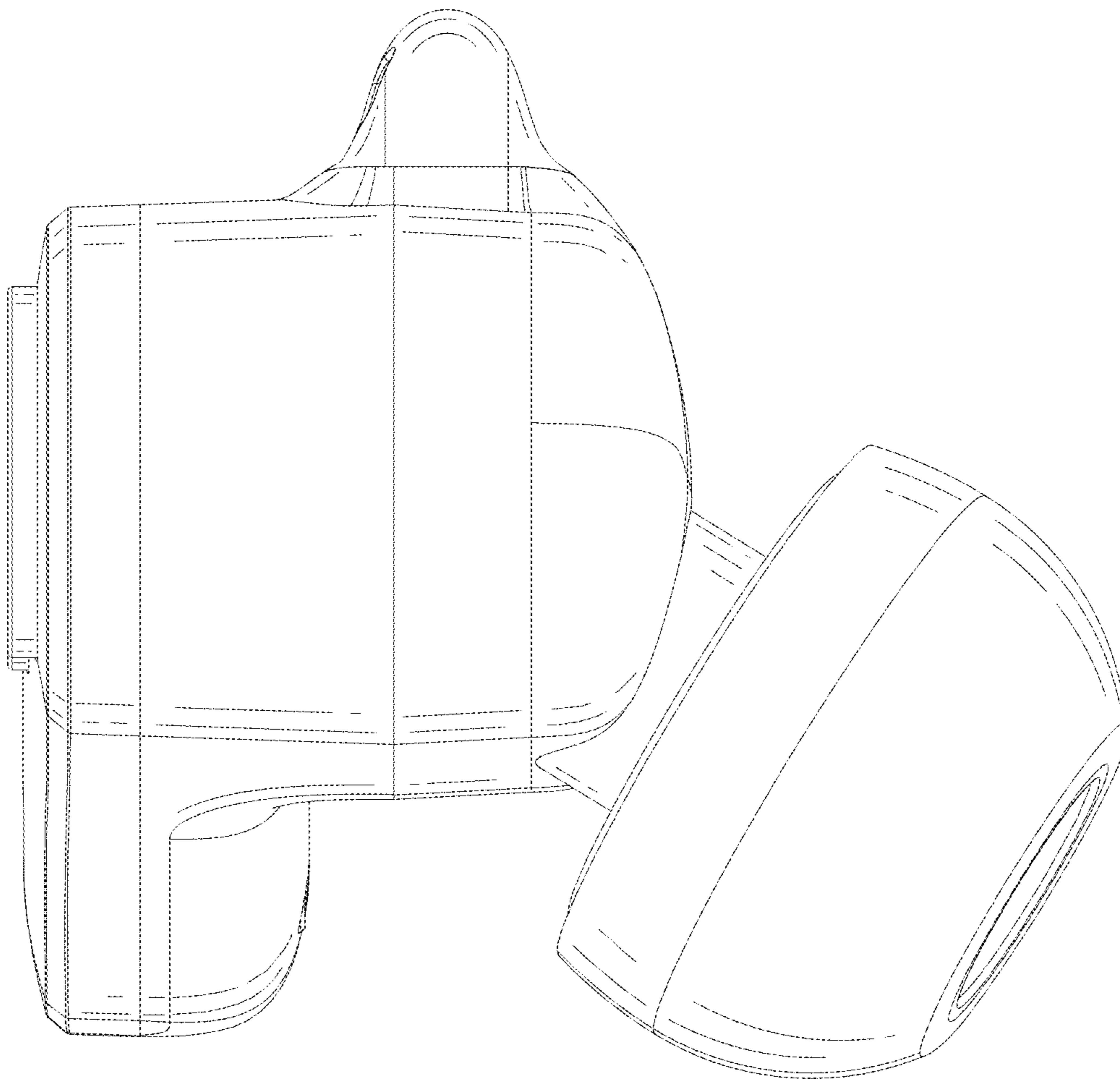


FIG. 8

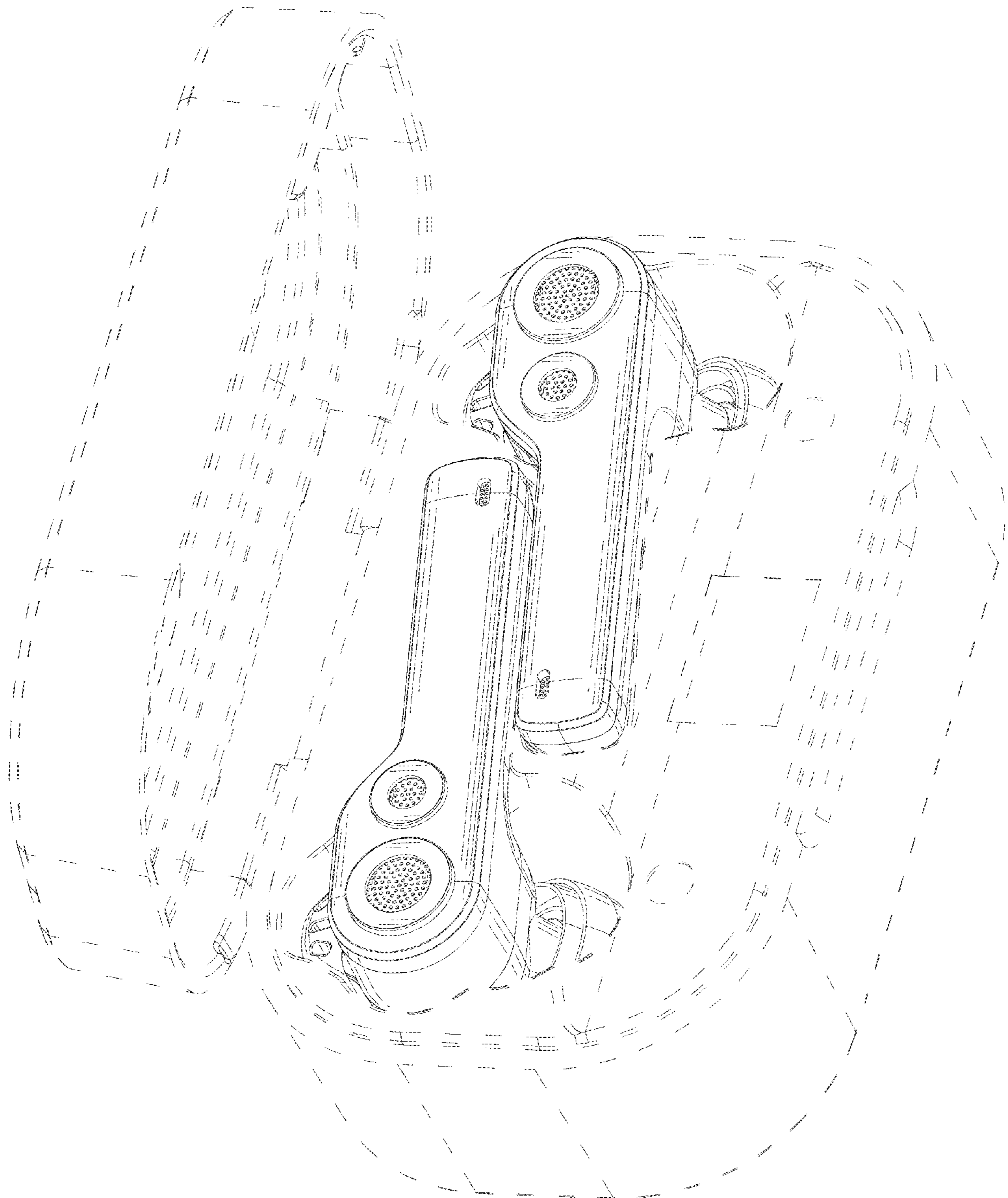


FIG. 9